

Ultra Efficient Energy Manager with Constant Voltage, Regulated Buck Output and 5 V CC/CV Charger

Features and Benefits

Cold start from 275 mV / 5 μW input

- Startup at ultra-low power from harvesting source input.

Maximum Power Point Tracking

- Matches various single/dual elements PV cells.
- Configurable MPPT ratios ranging from 35% to 90%.
- Configurable MPPT sensing timing and period.
- MPPT voltage operation range from 110 mV up to the storage element voltage.

Selectable overdischarge and overcharge protection

- Supports various types of rechargeable batteries (LiC, Li-ion, LiPo...).

Regulated output for application circuit

- Buck regulator with efficiency above 90 %.
- Selectable output voltage (2.2 V, 2.5 V or 2.8 V).
- Output current up to 135 mA.

System configuration by GPIO

- All settings are dynamically configurable through GPIO

Shipping mode

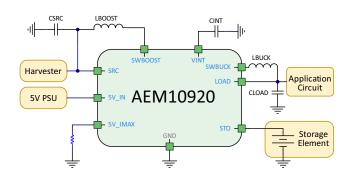
- Disables charging and discharging of the battery during shipment.

External 5 V charging capability

- Extra charging input for 5 V power supplies.
- CC/CV charging with configurable current limit in CC mode (max. 135 mA).
- Provides a fast charging alternative when no source is available for a long time.

Applications

Remote Controls	Wireless Keyboards	



Description

The AEM10920 is a fully integrated and compact power management circuit that extracts DC power from a harvesting source to store energy in a rechargeable battery and supply an application circuit. A 5 V input can also be used to charge the battery (e.g. if the battery gets depleted). This compact and ultra-efficient battery charger allows for extending battery lifetime and eliminating the primary energy storage in a large range of applications.

Thanks to a Maximum Power Point Tracking and a ultra-low power boost converter, the AEM10920 harvests the maximum available power from a source to charge a storage element.

With its unique cold-start circuit, it can start operating with an input voltage as low as 275 mV (min. 5 μ W power).

The configurable protection levels determine the storage element voltage protection thresholds to avoid overcharging and overdischarging the storage element and thus damaging it

A shipping mode is available to avoid charging and discharging of the storage element during shipping or storage.

A buck regulator with selectable output voltage allows an application circuit to be supplied with high efficiency.

Device Information

Part Number	Package	Body size	
10AEM10920A0000	QFN 24-pin	4x4mm	

Evaluation Board

Part number	
2AAEM10920Axxxx	



Table of Contents

1. Pin Configuration and Functions	5
2. Absolute Maximum Ratings	7
3. Thermal Resistance	7
4. Typical Electrical Characteristics at 25 °C	8
5. Recommended Operation Conditions	10
•	11
6. Functional Block Diagram	
7. Theory of Operation	12
7.1. Cold-Start Circuits	
7.2. Boost Converter	
7.2.1. Operation Principle	
7.2.2. Maximum Power Point Tracking	
7.4. Buck Converter	
7.5. State Machine Description	
7.5.1. Reset State	
7.5.2. Sense STO State	
7.5.3. Start State	
7.5.4. Supply State	
7.5.5. OVDIS State	
7.5.6. Sleep State	
8. System Configuration	16
8.1. Configuration Pins Reading	16
8.2. MPPT Configuration	
8.3. Storage Element Thresholds	
8.3.1. Configuration Pins	17
8.3.2. Custom mode	17
8.4. Boost Converter Timings	18
8.5. LOAD Output Voltage	
8.6. 5 V Charger	18
9. Typical Application Circuit	19
9.1. Example Circuit 1	19
9.2. Example Circuit 2	20
10. Performances	21
10.1. Boost Converter Conversion Efficiency	21
10.2. Buck Converter Conversion Efficiency	22
11. Minimum BOM	23
12. Layout	24
12.1. Guidelines	24
12.2. Example	
13. Package Information	25
13.1. Package Dimensions	25
14. Revision History	26

PRELIMINARY DATASHEET



List of Figures

Figure 1: Pinout diagram	5
Figure 2: Functional block diagram	
Figure 3: Simplified schematic view of the boost converter	12
Figure 4: Simplified schematic view of the buck converter	13
Figure 5: AEM10920 state machine	14
Figure 6: Custom configuration resistors	17
Figure 7: Typical application circuit 1	19
Figure 8: Typical application circuit 2	20
Figure 9: Boost converter efficiency	21
Figure 10: Buck (LOAD) converter efficiency	22
Figure 11: Layout example for the AEM10920 with associated passive components	24
Figure 12: QFN 24-pin 4x4mm drawing (all dimensions in mm)	25

PRELIMINARY DATASHEET



List of Tables

Table 1: Pins description (part 1)	5
Table 2: Pins description (part 2)	6
Table 3: Absolute maximum ratings	7
Table 4: Thermal data	7
Table 5: Electrical characteristics (part 1)	8
Table 6: Electrical characteristics (part 2)	9
Table 7: Recommended external components	10
Table 8: Logic input pin connections	10
Table 9: Configuration of MPP ratio and timings	16
Table 10: Storage element configuration with STO_CFG[1:0] pins	17
Table 11: Boost converter timings configuration	18
Table 12: Configuration of LOAD voltage with LOAD_CFG[1:0] pins	18
Table 13: Typical resistor values for setting 5 V charger max. current	18
Table 14: Minimum BOM	23
Table 15: Revision History	26



1. Pin Configuration and Functions

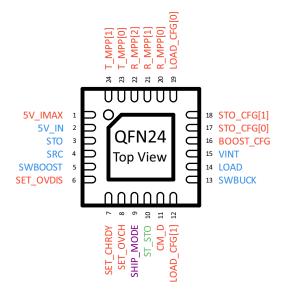


Figure 1: Pinout diagram

NAME	PIN NUMBER	FUNCTION
Power Pins		
SRC	4	Connection to the energy source harvested by the boost converter.
SWBOOST	5	Switching node of the boost converter.
STO	3	Connection to the energy storage element (rechargeable battery).
SWBUCK	13	Switching node of the buck converter.
LOAD	14	Output voltage of the buck converter to supply an application circuit.
5V_IN	2	Input of the 5 V DC power supply. (optional) Leave floating if not used.
VINT	15	Connection for C _{INT} buffering capacitor. AEM10920 internal power supply (do not connect any external circuit on VINT).

Table 1: Pins description (part 1)



NAME	PIN	LOGIC	LEVEL	FUNCTION	
INAIVIE	NUMBER	LOW	HIGH	FONCTION	
Control Pin					
SHIP_MODE	9	GND	STO	Logic input. When HIGH: - Minimum consumption from the storage element. - Storage element charge is disabled (boost converter is disabled). - Buck (LOAD) is disabled. - VINT is charged only if energy is available on SRC. Read as LOW if left floating.	
Configuration Pin	s				
R_MPP[2]	22	GND	VINT	Head for the confirmation of the MDD outin	
R_MPP[1]	21	GND	VINT	Used for the configuration of the MPP ratio. Read as HIGH when left floating.	
R_MPP[0]	20	GND	VINT	Read as fileft when left floating.	
T_MPP[1]	24	GND	VINT	Used for the configuration of the MPP timings.	
T_MPP[0]	23	GND	VINT	Read as HIGH when left floating.	
STO_CFG[1]	18	GND	VINT	Used to configure the storage element voltage thresholds.	
STO_CFG[0]	17	GND	VINT	Read as HIGH if left floating.	
LOAD_CFG[1]	12	GND	VINT	Head to configure the LOAD outsut you detice uplace. Dood collicit if left floation	
LOAD_CFG[0]	19	GND	VINT	Used to configure the LOAD output regulation voltage. Read as HIGH if left floating.	
BOOST_CFG	16	GND	VINT	Used to configure the boost converter timings, as described in Section 8.4.	
5V_IMAX 1 Analog Pin		og Pin	Connection to an external resistor to set the charging current from the 5V_IN supply to STO. Leave floating if the 5V_IN power supply is not used.		
SET_OVDIS	6			Used for the configuration of the threshold voltages for the energy storage element	
SET_CHRDY	7			when in custom mode (optional).	
SET_OVCH	8		ъ.	If the custom mode is not used:	
CM_D	11	Anaid	og Pin	 Connect CM_D to GND. Connect SET_OVDIS / SET_CHRDY / SET_OVCH either to any voltage between 0 V (GND) and V_{STO}, or leave them floating. 	
Status Pin					
ST_STO	10	GND	STO	Logic output. - HIGH when in SUPPLY STATE and SLEEP STATE LOW otherwise.	
Other pins					
GND	Thermal pad			The thermal pad must be strongly tied to the PCB ground plane, as it is the main GND connection of the AEM10920.	

Table 2: Pins description (part 2)



2. Absolute Maximum Ratings

Parameter Value Operating junction temperature TBD ESD HBM voltage TBD ESD CDM voltage TBD

Table 3: Absolute maximum ratings

3. Thermal Resistance

Package	θJΑ	θЈС	Unit
TBD	TBD	TBD	°C/W

Table 4: Thermal data

ESD CAUTION



ESD (ELECTROSTATIC DISCHARGE) SENSITIVE DEVICE

These devices have limited built-in ESD protection and damage may thus occur on devices subjected to high-energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality



4. Typical Electrical Characteristics at 25 °C

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Power conver	rsion					
P _{SRC,CS}	Minimum source power required for co	ld start.		5		μW
V _{SRC,CS}	Minimum source voltage required for co	old start.		0.275		V
V _{MPP}	Dynamically determined target regulati V _{MPP} depends on R_MPP[2:0] configuration voltage of the source V _{OC} .	0.12		V _{STO}	V	
V _{OC}	Open-circuit voltage of the source.	Open-circuit voltage of the source.				V
V _{5V_IN}	Voltage on the 5V_IN pin to allow for ch	narging the battery.	3.50		5.50	V
D	Minimum power on 5V_IN to start	V _{5V_IN} = 3.50 V		51		\٨/
P _{5V_IN,MIN}	charging the battery.	V _{5V_IN} = 5.50 V		80		μW
I _{5V,CC}		Maximum charging current of 5 V charger when in constant current (CC) mode. This is programmed by the resistor on the 5V_IMAX pin.			135	mA
Timing						
T _{CRIT}	In SUPPLY STATE, the AEM10920 waits for STATE when V _{STO} drops below V _{OVDIS} .		2.50		S	
T _{GPIO,MON}	GPIO reading rate.			1.85		S

Table 5: Electrical characteristics (part 1)

^{1.} When the open-circuit voltage is below the source regulation voltage, the AEM10920 does not extract power from the source. Voltages down to GND voltage does not damage the AEM10920 though.



Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
Storage elem	Storage element									
V _{STO}	Voltage on the storage element.		2.40 ¹		4.59 ²	V				
V _{OVDIS}	Minimum voltage accepted on the storage element before stopping to supply LOAD.	Configured by STO_CFG[1:0] or by the custom mode.	2.40		3.58	V				
V _{CHRDY}	Voltage required on the storage element to start supplying LOAD in START STATE.	Configured by STO_CFG[1:0] or by the custom mode.	2.46		3.64	V				
V _{OVCH}	Maximum voltage accepted on the storage element before disabling its charging.	Configured by STO_CFG[1:0] or by the custom mode.	2.7		4.59	V				
Internal supp	ly & quiescent current									
V _{INT}	Internal voltage supply.		2.20	2.25	2.30	V				
V _{INT,RESET}	Minimum voltage on VINT before switch other state).	Minimum voltage on VINT before switching to RESET STATE (from any other state).				V				
V _{INT,CS}	Minimum voltage on VINT to allow the Al STATE to SENSE STO STATE.	EM10920 to switch from RESET		2.3		V				
I _{QSUPPLY}	Quiescent current on VINT in SUPPLY STA	ATE. ³		TBD		nA				
I _{QSLEEP}	Quiescent current on VINT in SLEEP STAT		TBD		nA					
I _{QSHIP,SRC}	Quiescent current on STO when the shipping mode functionality is enabled (SHIP_MODE set HIGH).	Energy on SRC.		10		nA				

Table 6: Electrical characteristics (part 2)

- 1. As set by the battery overdischarge threshold configuration.
- 2. As set by the battery overcharge threshold configuration.
- ${\it 3. When neither the boost converter nor the buck converter are running.}$



5. Recommended Operation Conditions

Symbol	Parameter	Min ¹	Тур	Max ¹	Unit
External component	s				
L _{BOOST}	Inductor of the boost converter.	4.7		33	μН
C _{SRC}	Capacitor decoupling the SRC terminal.		10		μF
L _{BUCK}	Inductor of the buck converter.	3.75	15		μН
C _{LOAD}	Capacitor of the buck converter.	TBD			μF
C _{INT}	Capacitor decoupling the VINT terminal.	5	10		μF
R _{5V_IMAX}	Resistor for configuring the 5V charger current when in constant current mode (CC). (Optional)	0.37		3.7	kΩ
R _T	Optional - Resistor for setting threshold voltage of the battery in custom mode	0.1		0.4	ΜΩ

Table 7: Recommended external components

^{1.} All minimum and maximum values are real components values, taking into account tolerances, derating, temperatures, voltages and any operating conditions (special care must be taken with capacitor derating).

Symbol	Parameter				
Logic input pins	Logic input pins				
R_MPP[2:0]	Boost source MPPT settings.	Logic LOW (L)	Connect to GND.		
T_MPP[1:0]		Logic HIGH (H)	Connect to VINT.		
STO_CFG[1:0]	Storage element voltage thresholds configuration.	Logic LOW (L)	Connect to GND.		
		Logic HIGH (H)	Connect to VINT.		
LOAD_CFG[1:0]	Configuration of the LOAD buck output voltage regulation.	Logic LOW (L)	Connect to GND.		
		Logic HIGH (H)	Connect to VINT.		
SHIP MODE	Chinaina anada anahla	Logic LOW (L)	Connect to GND.		
SHIP_INIODE	Shipping mode enable.	Logic HIGH (H)	Connect to STO.		

Table 8: Logic input pin connections



6. Functional Block Diagram

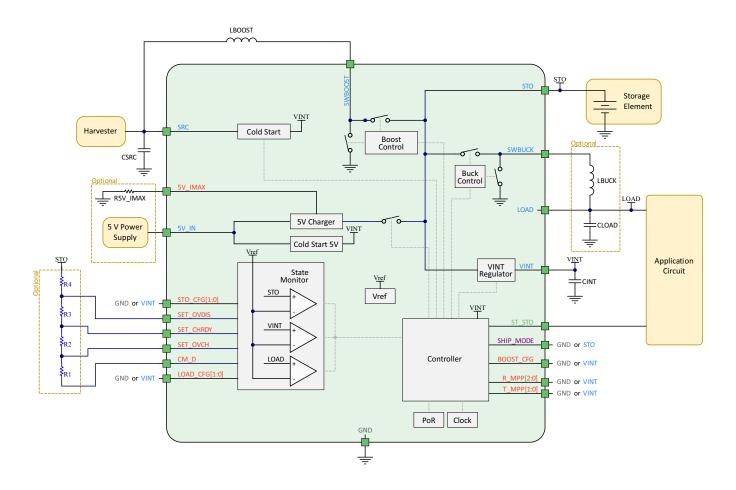


Figure 2: Functional block diagram



7. Theory of Operation

7.1. Cold-Start Circuits

The AEM10920 is able to coldstart from SRC or from 5V_IN. The cold-start circuits supply the AEM10920 internal circuit (connected to VINT) when the device is in RESET STATE, SENSE STO STATE or OVDIS STATE.

7.2. Boost Converter

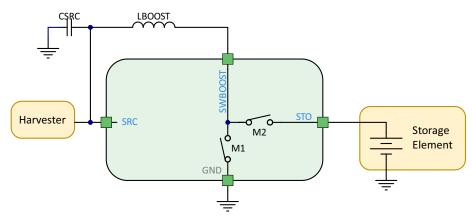


Figure 3: Simplified schematic view of the boost converter

7.2.1. Operation Principle

The boost (step-up) converter raises the voltage available at SRC to a level suitable for charging the storage element, in the range of 2.40 V to 4.59 V, according to the system configuration. The switching transistors of the boost converter are M1 and M2. The reactive power component of this converter is the external inductor L_{BOOST} .

Target source regulation voltage is determined by the source voltage regulation (dynamically determined by the MPPT module).

SRC is decoupled by the capacitor C_{SRC} , which smooths the voltage against the current pulses induced by the boost converter.

The storage element is connected to the STO pin, which voltage is V_{STO}. This node is linked to the output of the boost converter through transistor M2. When energy harvesting is occurring, the converter charges the battery.

The maximum current supplied to the STO pin depends on the value of L_{BOOST} and on the BOOST_CFG settings (see Section 8.4).

7.2.2. Maximum Power Point Tracking

The AEM10920 has a Maximum Power Point Tracking (MPPT) module, that relies on the fact that, for several models of harvesters (typ. solar cells), the ratio between the maximum power point voltage (V_{MPP}) and the open circuit voltage (V_{OC}) is constant for a wide range of harvesting conditions. For a solar cell, that means that V_{MPP}/V_{OC} is constant for any lighting conditions, even though both voltages increase when luminosity increase.

The MPP ratio (V_{MPP}/V_{OC}) differs from one harvester model to the other. User must set the MPP ratio to match the specifications of the harvester model used and thus maximize power extraction. This ratio is set with the configuration pins R_MPP[2:0] according to Table 9.

The MPPT module evaluates the open circuit voltage V_{OC} periodically to ensure optimal power extraction at any time. The sampling period $T_{MPPT,PERIOD}$ and sampling duration $T_{MPPT,SAMPLING}$ of the evaluation of V_{OC} are set according to Table 9 with the configuration pins $T_{MPPT,SAMPLIOD}$, the AEM10920 stops extracting power from the source, waits during $T_{MPPT,SAMPLING}$ for the source to rise to its open circuit voltage V_{OC} , and measures V_{OC} .

The AEM10920 supports multiple V_{MPP} levels in the range from 0.11 V to V_{STO} . It offers a choice of eight values for the V_{MPP} / V_{OC} fraction.

The MPPT module is active during START STATE, OVDIS STATE, SUPPLY STATE and SLEEP STATE.



7.3. 5V Charger

The AEM10920 is equipped with a 5 V charger for fast charging of the battery connected on the STO pin. When a voltage higher than 3.5 V and V_{STO} is detected on the $5V_{LN}$ pin, the charger starts charging the battery, implementing a constant current / constant voltage operation (CC/CV):

- Constant current (CC) operation:
 - When V_{STO} is not close to V_{OVCH}.
 - Battery charging current I_{SV,CC} is configured by the value of the R_{SV_IMAX} resistor connected to the SV_IMAX pin (see Section 8.6 for further details about R_{SV_IMAX} configuration). I_{SV,CC} range is from 13.5 mA to 135 mA.
- Constant voltage (CV) operation:
 - When V_{OVCH} is close to V_{OVCH}.
 - The charging current I_{SV,CV} gradually decreases to zero as the V_{STO} reaches V_{OVCH}.

Using the 5 V charger is not mandatory. When not used, leave both 5V IN and 5V IMAX pins floating.

7.4. Buck Converter

The buck (step-down) converter transfers energy from the battery connected on STO to the regulated LOAD output. The switching transistors of the buck converter are M3 and M4. The reactive power component of this converter is the external inductor L_{BUCK} . LOAD is decoupled by the capacitor C_{LOAD} , which smooths the voltage against the current pulses induced by the consumption of the external circuit connected to LOAD.

Setting the LOAD regulation voltage V_{LOAD} is done through LOAD_CFG[1:0] pins.

After cold start, the buck converter starts once V_{STO} is higher than V_{CHRDY} . It stays enabled, and thus regulates V_{LOAD} , until V_{STO} drops below V_{OVDIS} longer than T_{CRIT} .

When the difference between V_{STO} and V_{LOAD} is smaller than 0.25V, it switches to "bang-bang" controlled converter mode:

- When V_{LOAD} is too low, a switch connects STO directly to LOAD, making V_{LOAD} rise.
- When V_{LOAD} is too high, the controller disconnects STO and LOAD so that V_{LOAD} decreases.

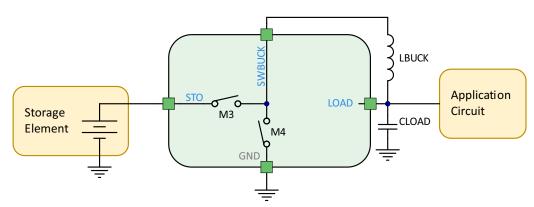


Figure 4: Simplified schematic view of the buck converter



7.5. State Machine Description

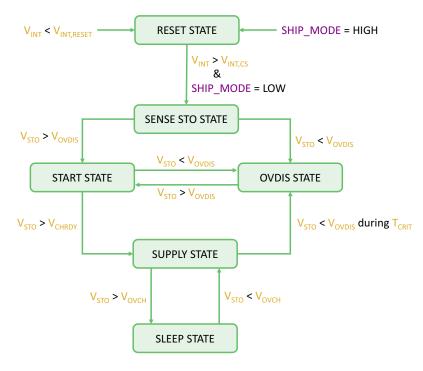


Figure 5: AEM10920 state machine

7.5.1. Reset State

The AEM10920 enters RESET STATE if one of the following is true:

- V_{INT} is below 2 V.
- shipping mode is enabled (SHIP MODE is HIGH).

In RESET STATE, the AEM10920 behaves as follows:

- The AEM10920 is performing a cold start to make V_{INT} rise to 2.3 V. Cold start can be done from any of the following energy sources:
 - SRC (V_{SRC} > 0.275 V and $P_{SRC,CS}$ > 5 μ W).
 - $5V_{IN} (V_{5V IN} > 3.5 V)$.
- The AEM10920 internal circuit, connected on VINT, is supplied by SRC or 5V_IN. No current is drawn from the battery.
- ST_STO is LOW.

The AEM10920 stays in RESET STATE until the power available on either SRC meets the cold-start requirements long enough to make V_{INT} reach 2.3 V (see Table 5). Then:

- If shipping mode is disabled (SHIP_MODE is LOW), the AEM10920 reads the value on all configuration pins and switches to SENSE STO STATE.
- If shipping mode is enabled (SHIP_MODE is HIGH), the AEM10920 stays in RESET STATE until shipping mode is disabled by setting SHIP_MODE LOW. SHIP_MODE is read every T_{GPIO.MON}.

Please note that, from any state, the AEM10920 will switch to RESET STATE if $V_{\rm INT}$ drops below 2 V.

7.5.2. Sense STO State

In SENSE STO STATE, a first measure of V_{STO} is performed by the AEM10920.

- If V_{STO} > V_{OVDIS}, the AEM10920 switches to START
- If $V_{STO} < V_{OVDIS}$, the AEM10920 switches to OVDIS STATE.
- ST_STO is LOW.

In SENSE STO STATE, none of the DCDC converters are running.



7.5.3. Start State

When in SENSE STO STATE, the AEM10920 switches to START STATE if V_{STO} is above V_{OVDIS} .

In START STATE, the AEM10920 behaves as follows:

- The battery connected on STO is charged by the boost converter or by the 5 V charger, until V_{STO} reaches V_{CHRDY}.
- The AEM10920 internal circuit connected on VINT is supplied by the battery regardless of the power available on SRC or 5V IN.
- The buck converter (LOAD) is disabled.
- ST_STO is LOW.

7.5.4. Supply State

When in START STATE, the AEM10920 switches to SUPPLY STATE if V_{STO} is above V_{CHRDY}.

In SUPPLY STATE, the AEM10920 behaves the same as when in START STATE, but with the following differences:

- The buck converter driving LOAD is enabled (if enabled by the user).
- ST STO is HIGH.

When in SUPPLY STATE, the AEM10920 switches to SLEEP STATE if the following condition is met:

- $V_{STO} > V_{OVCH}$.

In SUPPLY STATE, the AEM10920 switches to OVDIS STATE if the following condition is met:

- V_{STO} < V_{OVDIS} during T_{CRIT}

7.5.5. OVDIS State

The AEM10920 switches to OVDIS STATE if:

- V_{STO} is below V_{OVDIS} when in SENSE STO STATE or START STATE.
- V_{STO} remains below V_{OVDIS} for more than T_{CRIT} when in SUPPLY STATE.

In OVDIS STATE, the AEM10920 behaves as follows:

- The battery connected on STO is charged by the boost converter or by the 5 V charger, until V_{STO} exceeds V_{OVDIS}.
- The AEM10920 internal circuit, connected on VINT, is supplied by SRC or 5V_IN. If not enough power is available on either of those pins, the AEM10920 switches to RESET STATE. No current is drawn from the battery.
- The buck converter (LOAD) is disabled.
- ST STO is LOW.

7.5.6. Sleep State

SLEEP STATE allows for reducing the AEM10920 internal circuit consumption when the battery is fully charged. Thus, battery discharging is kept minimal.

In SLEEP STATE, the AEM10920 behaves as follows:

- The battery connected on STO is not charged by SRC, allowing for reducing the quiescent current on VINT and thus on STO.
- The AEM10920 internal circuit connected on VINT is supplied by the battery regardless of the power available on SRC or 5V_IN.
- The buck converter (LOAD) is enabled.
- ST_STO is HIGH.

When in SLEEP STATE, the AEM10920 switches back to SUPPLY STATE if V_{STO} < V_{OVCH} .



8. System Configuration

8.1. Configuration Pins Reading

After a cold start, the AEM10920 reads the configuration pins. Those are then read periodically every $T_{\text{GPIO},\text{MON}}$. The configuration pins can be changed on-the-fly. The floating configuration pins are read as HIGH, except SHIP_MODE which is read as LOW.

8.2. MPPT Configuration

Two parameters are necessary to configure the Maximum Power Point Tracking (MPPT). The first parameter is the MPP tracking ratio, which is selected according to the characteristics of the input power source. This parameter is set by the configuration pins R_MPP[2:0].

The second parameter allows configuring the duration of the evaluation of V_{OC} and the time between two MPP evaluations. This configuration is set by the configuration pins T MPP[1:0].

Configuration			Function
R_MPP[2:0]		:0]	V _{MPP} / V _{OC}
L	L	L	35%
L	L	Н	50%
L	Н	L	65%
L	Н	Н	70%
Н	L	L	75%
Н	L	Н	80%
Н	Н	L	85%
Н	Н	Н	90%

Configuration		Function		
T_MP	P[1:0]	T _{MPPT,PERIOD} [s]	T _{MPPT,SAMPLING} [s]	
L	L	15	0.25	
L	Н	15	0.50	
Н	L	25	0.25	
Н	Н	25	0.50	

Table 9: Configuration of MPP ratio and timings



8.3. Storage Element Thresholds

Two methods are available to configure the storage element voltage thresholds V_{OVDIS} , V_{CHRDY} and V_{OVCH} :

- Configuration through the STO_CFG[2:0] pins as described in Section 8.3.1.
- Configuration using the custom mode as described in Section 8.3.2.

8.3.1. Configuration Pins

The storage element protection thresholds V_{OVCH}, V_{CHRDY} and V_{OVCH}, can be configured through the STO_CFG[1:0] pins as shown in Table 10.

Configura	ation pins	Overdischarge voltage [V]	Charge ready voltage [V]	Overcharge voltage [V]	Battery Type
STO_C	FG[1:0]	V _{OVDIS}	V _{CHRDY}	V _{OVCH}	
L	L	2.50	2.55	3.80	Lithium-ion Super Capacitor (LiC)
L	Н	3.00	3.20	4.12	Lithium-ion battery
Н	L	3.00	3.20	4.35	LiPo battery
Н	Н	3.50	3.55	3.90	Li-ion battery (ultra long life)

Table 10: Storage element configuration with STO_CFG[1:0] pins

8.3.2. Custom mode

When CM_D is not connected to GND, the custom mode is selected regardless of STO_CFG[1:0] pins and all four configuration resistors shown in Figure 6, must be wired as follows:

 V_{OVCH} , V_{CHRDY} and V_{OVDIS} are defined thanks to R_1 , R_2 , R_3 and R_4 . Defining R_T as follows, R_1 , R_2 , R_3 and R_4 are calculated as:

- $R_T = R_1 + R_2 + R_3 + R_4$
- $100 k\Omega \le R_T \le 400 k\Omega$

$$- R_1 = R_T \cdot \frac{0.5V}{V_{OVCH}}$$

$$- R_2 = R_T \cdot \left(\frac{0.5V}{V_{CMRDY}} - \frac{0.5V}{V_{OVCK}} \right)$$

$$\begin{aligned} & - & & R_1 = & R_T \cdot \frac{0.5V}{V_{OVCH}} \\ & - & R_2 = & R_T \cdot \left(\frac{0.5V}{V_{CHRDY}} - \frac{0.5V}{V_{OVCH}}\right) \\ & - & R_3 = & R_T \cdot \left(\frac{0.5V}{V_{OVDIS}} - \frac{0.5V}{V_{CHRDY}}\right) \end{aligned}$$

$$- R_4 = R_T - (R_1 + R_2 + R_3)$$

The following constraints must be met to ensure the functionality of the chip:

- 2.40 V < V_{OVDIS} < 3.58 V
- 2.46 V < V_{CHRDY} < 3.64 V
- 2.70 V < V_{OVCH} < 4.59 V
- V_{CHRDY} + 0.05 V < V_{OVCH} < 4.59 V
- V_{OVDIS} + 0.05 V < V_{CHRDY} < V_{OVCH} 0.05 V
- V_{OVDIS} > V_{LOAD}

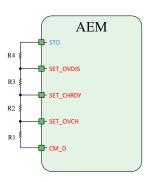


Figure 6: Custom configuration resistors



8.4. Boost Converter Timings

The BOOST_CFG pin allows for modifying the peak current of the boost inductor by multiplying the on/off timings of the boost converter, as shown in Table 11. The higher the timing multiplier, the higher the boost inductor peak current, and thus the higher the average source current pulled from SRC to STO.

The peak current in the inductor also depends on the value of the inductor. Table 11 shows the minimum inductor value to be implemented for each timing value. Lower value may lead to damaging the AEM10920.

Configuration pin	Function		
BOOST_CFG	Timing multiplication factor	Minimum L _{BOOST} inductance [μΗ]	
L	x1	4	
Н	х3	12	

Table 11: Boost converter timings configuration

8.5. LOAD Output Voltage

Table 12 shows how to configure the regulated voltage on LOAD output with the LOAD CFG[1:0] pins.

Config pi	uration ns	LOAD voltage [V]
LOAD_CFG[1:0]		V _{LOAD}
L	L	OFF
L	Н	2.2
Н	L	2.5
Н	Н	2.8

Table 12: Configuration of LOAD voltage with LOAD_CFG[1:0] pins

The buck voltage cannot be selected smaller than V_{OVDIS} . In such situation, the AEM10920 will not start the buck converter.

8.6. 5 V Charger

The 5 V charger implements CC/CV operation. When in CC, the maximum charging current $I_{5V,CC}$ can be set by connecting a resistor $R_{5V\ IMAX}$ between $5V_IMAX$ and GND:

$$I_{5V,CC} = \frac{50}{R_{5V_MAX}}$$

Please note that R_{5V_IMAX} must be chosen so that I_{5V,CC} complies to the range defined in Table 5. Example values can be found in Table 13:

Resistor [Ω]	Maximum Charging Current [mA]
R _{5V_IMAX}	I _{5V,CC}
370	135.0
680	73.5
1500	33.3
3700	13.5

Table 13: Typical resistor values for setting 5 V charger max.



9. Typical Application Circuit

9.1. Example Circuit 1

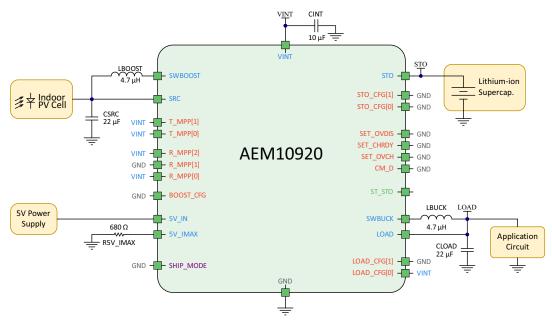


Figure 7: Typical application circuit 1

Figure 7 shows a typical application circuit of the AEM10920.

Configuration of SRC

The second energy source is an indoor PV cell which has an 80% MPP ratio. SRC is thus configured as follows:

- R_MPP[2:0] = HLH: 80% ratio.
- T_MPP[1:0] = HH:
 - $T_{MPPT,PERIOD} = 25s$.
 - T_{MPPT,SAMPLING} = 0.5s.
- BOOST_CFG = L: x1 boost timing.
- L_{BOOST} = 4.7 μ H for best efficiency with x1 boost timing (see Section 8.4) and low-cost inductor.

Configuration of STO

The storage element is a Lithium-ion supercapacitor, so storage element threshold voltages are set as follows:

- STO_CFG[1:0] = LL.
 - V_{OVDIS} = 2.5 V.
 - $V_{CHRDY} = 2.55 \text{ V}.$
 - V_{OVCH} = 3.8 V.
- Custom mode is not used so CM_D, SET_OVDIS, SET_CHRDY and SET_OVCH are connected to GND.

Configuration of **LOAD**

The application circuit is supplied with 2.2 V with current peaks up to 40 mA. The buck converter is configured as follows:

- LOAD_CFG[1:0] = LH (2.2 V)
- L_{BUCK} = 4.7 μH for high current capability and low cost inductor.

Configuration of 5V_IN

The maximum allowed current to charge the storage element is 75 mA. Closest standard series resistor is 680 Ω , which leads to a 73.5 mA maximum current.

- $R_{5V \text{ IMAX}} = 680 \Omega$.
- $I_{5V,CC} = 73.5 \text{ mA}.$

Shipping mode

Shipping mode is not used.

- SHIP_MODE is connected to GND.



9.2. Example Circuit 2

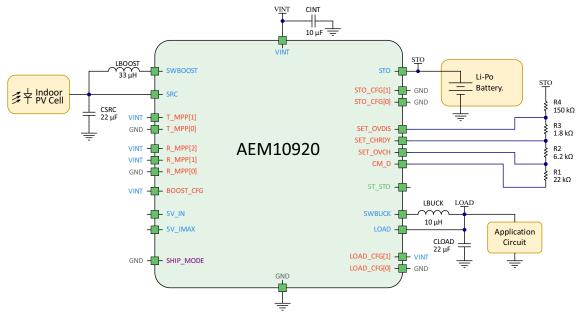


Figure 8: Typical application circuit 2

Figure 8 shows a typical application circuit of the AEM10920.

Configuration of SRC

The second energy source is an indoor PV cell which has an 85% MPP ratio. SRC is thus configured as follows:

- R_MPP[2:0] = HHL: 85% ratio.
- T_MPP[1:0] = HL:
 - $T_{MPPT,PERIOD} = 25s.$
 - $T_{MPPT,SAMPLING} = 0.25s$.
- BOOST CFG = H: x3 boost timing.
- L_{BOOST} = 33 μH for best efficiency with x3 boost timing (see Section 8.4).

Configuration of STO

The storage element is a Lithium-Polymer (Li-Po) battery used with custom voltage thresholds set as follows:

- STO_CFG[1:0] = LL: AEM10920 ignores STO_CFG[1:0] settings as CM_D is not set to GND (custom mode is used).
- Desired storage element voltage thresholds are the following:
 - V_{OVDIS} = 3.0 V.
 - V_{CHRDY} = 3.2 V.
 - V_{OVCH} = 4.1 V.

- Custom mode resistors are configured as follows:

-
$$R_T = R_1 + R_2 + R_3 + R_4 = 180 k\Omega$$

$$- \quad R_1 \, = \, R_T \cdot \frac{0.5 V}{V_{OVCH}} = \, 22 k \Omega$$

-
$$R_2 = R_T \cdot \left(\frac{0.5V}{V_{CHRDY}} - \frac{0.5V}{V_{OVCH}}\right) = 6.2k\Omega$$

$$- R_3 = R_T \cdot \left(\frac{0.5V}{V_{OVDIS}} - \frac{0.5V}{V_{CHRDY}}\right) = 1.8k\Omega$$

-
$$R_4 = R_T - (R_1 + R_2 + R_3) = 150k\Omega$$

Configuration of LOAD

The application circuit is supplied with 2.5 V with current peaks up to 10 mA. The buck converter is configured as follows:

- LOAD_CFG[1:0] = HL (2.5 V)
- L_{BUCK} = 10 μ H for best efficiency.

Configuration of 5V IN

5 V charger is not used so both 5V_IN and 5V_IMAX are left floating.

Shipping mode

Shipping mode is not used.

- SHIP_MODE is connected to GND.



10. Performances

10.1. Boost Converter Conversion Efficiency

Figure 9 shows the AEM10920 boost efficiency with:

- L_{BOOST} = 33 μ H (Coilcraft LPS4018-333MRB).
- BOOST_CFG = H (x3).

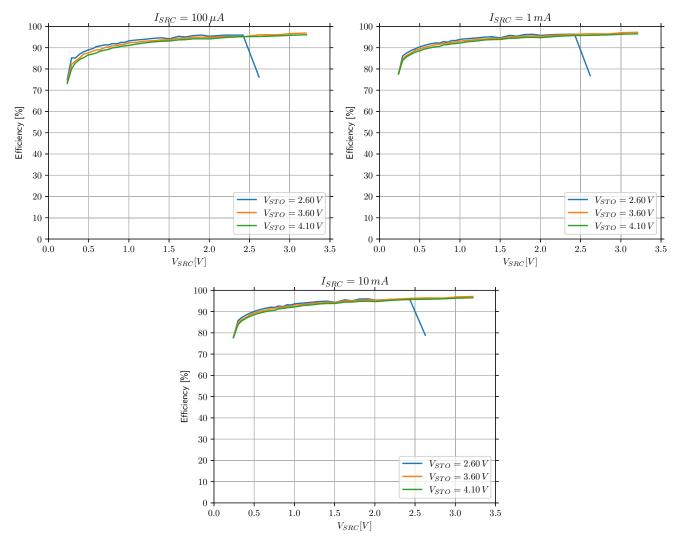


Figure 9: Boost converter efficiency



10.2. Buck Converter Conversion Efficiency

Figure 10 shows the AEM10920 buck efficiency with L_{BUCK} = 10 μH (TDK VLS252012CX-100M-1).

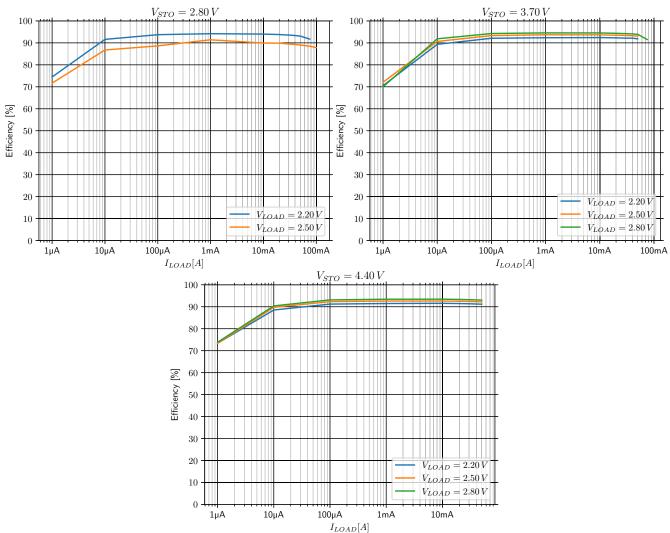


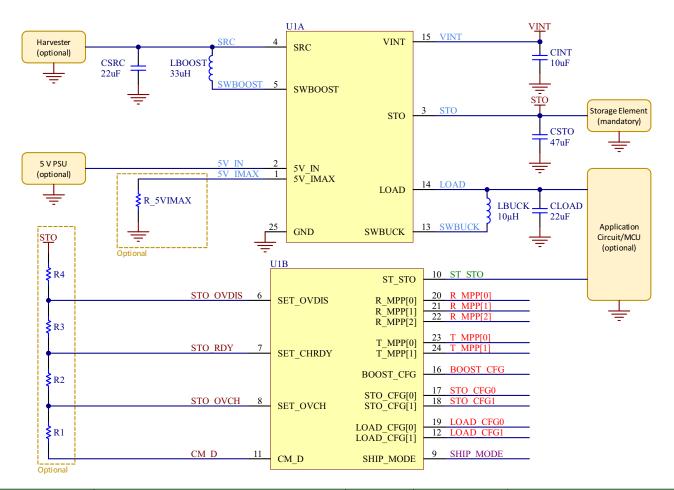
Figure 10: Buck (LOAD) converter efficiency

Figure 10 efficiency is shown with the AEM10920 boost-related quiescent current subtracted from the current provided on STO:

- This quiescent current is measured with the boost converter in SLEEP STATE and with the buck converter switched off, so that the current that is necessary to run the buck converter is considered in Figure 10 data.
- It is considered in the boost efficiency data shown in Section 10.1.



11. Minimum BOM



De	esignator	Description	Quantity	Manufacturer	Part Number	
>	U1	AEM10920	1	e-peas	order at sales@e-peas.com	
atory	CSRC	Ceramic Capacitor 22 μF, 10 V, 20%, X5R 0603	1	Murata	GRM188R61A226ME15D	
Mand	LBOOST	Power Inductor 33 μH, 0.68 A, LPS4018	1	Coilcraft	LPS4018-333MRB	
Σ	CINT	Ceramic Capacitor 10 μF, 6.3 V, 20%, X5R, 0402	1	Murata	GRM155R60J106ME44D	
	CSTO ¹	Ceramic Capacitor 47 μF 6.3 V, 20%, X5R, 0603	1	Murata	GRM188R60J476ME15D	
	R_5VIMAX ²	Resistor (to be defined)	1	To be defined	pe defined	
	LBUCK	Power Inductor 10 μF TDK VLS-CX-1	1	TDK	VLS252012CX-100M-1	
	CLOAD	Ceramic Capacitor 22 μF, 10 V, 20%, X5R, 0603	1	Murata	GRM188R61A226ME15D	
	R1		1			
<u>a</u>	R2	Resistors (to be defined)	1	To be defined		
Optional	R3	nesistors (to be defined)	1			
ğ	R4		1			

Table 14: Minimum BOM

^{1.} CSTO is not mandatory but ensures high boost converter efficiency with high ESR storage elements.

^{2.} The AEM10920 must have at least one energy source to work: boost (SRC), 5 V input (5V_IN) or both.



12. Layout

12.1. Guidelines

Figure 11 shows an example of PCB layout with AEM10920.

The following guidelines must be applied for best performances:

- Make sure that ground and power signals are routed with large tracks. If an internal ground plane is used, place via as close as possible to the components, especially for decoupling capacitors.
- Reactive components related to the boost/buck converter must be placed as close as possible to the corresponding pins (SWBOOST, SRC, STO, SWBUCK and LOAD), and be routed with large tracks/polygons.
- PCB track capacitance must be reduced as much as possible on the boost converter switching node SWBOOST, as well as on the buck converter switching node SWBUCK. This is done as follows:
 - Keep the connection between the SWBOOST/ SWBUCK pins and the corresponding inductor short.
 - Remove the ground and power planes under the SWBOOST/SWBUCK nodes. The polygon on the opposite external layer may also be removed.
 - Increase the distance between SWBOOST/ SWBUCK and the ground polygon on the external PCB layer where the AEM10920 is mounted.

12.2. Example

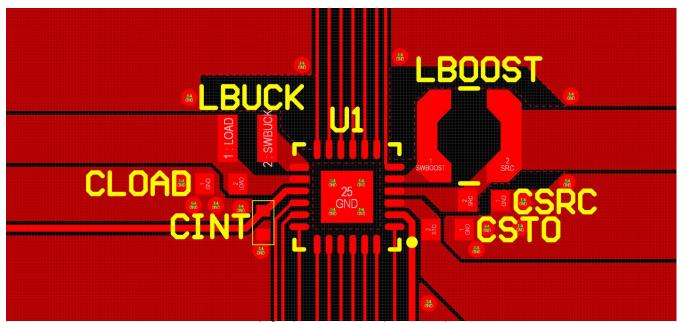


Figure 11: Layout example for the AEM10920 with associated passive components



13. Package Information

13.1. Package Dimensions

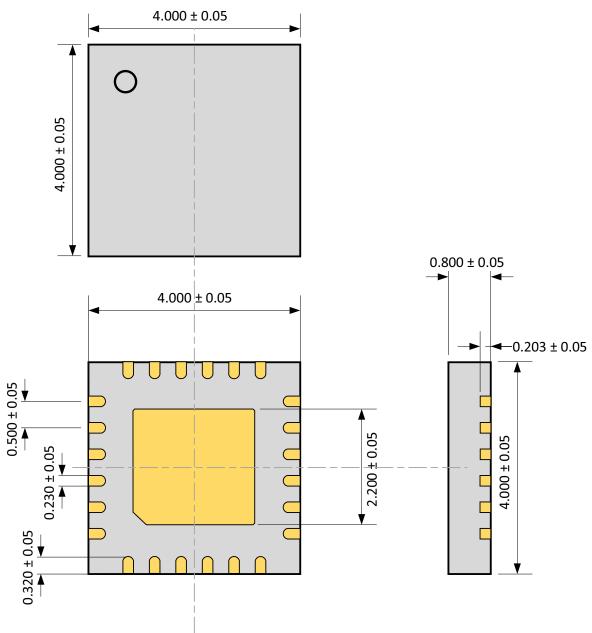


Figure 12: QFN 24-pin 4x4mm drawing (all dimensions in mm)



14. Revision History

Revision	Date	Description	
1.0	December, 2023	Creation of the document.	
1.1	January, 2024	 "Configuration of MPP ratio and timings" table: fixed wrong column title. Added typical application circuit. 	

Table 15: Revision History